07-12-01

Express Mail No. ET160381264US 03CO Attorney Docket No.: AM-2772.P1

THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Ajay Kumar et al.

§ GROUP ART UNIT: Unknown

SERIAL NO.: 09/882,323

EXAMINER: Unknown

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§ §

FILED: June 13, 2001

JUL 1 1 2001

§ Attorney Docket No.:

FOR: METHOD FOR ETCHING SILICON NITRIDE

§ Attorney Docket]
§ AM-2772.P1

Date: July 11, 2001

INFORMATION DISCLOSURE STATEMENT TRANSMITTAL LETTER

Hon. Commissioner for Patents Washington, DC 20231

Sir:

Applicants are submitting the subject Information Disclosure Statement under 37 CFR § 1.97(b)(1). This Information Disclosure Statement is being submitted within three (3) months of the filing date of the subject application.

CERTIFICATE OF MAILING UNDER 37 CFR 1.10

I hereby certify that this paper is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as U.S. EXPRESS MAIL NO. ET160381264US in an envelope addressed to the: Commissioner for Patents, Box DD, Washington, DC 20231.

Date: July 11, 2001

Shirley L. Church, Reg. No. 31,858

Applicants do not believe that any fee is due in connection with the filing of this Information Disclosure Statement under 37 CFR § 1.97(b)(1). However, in the event that any additional fee is due, the Commissioner is hereby authorized to charge Deposit Account No. 50-1512 of Shirley L. Church, Sunnyvale, California, in the amount of such fee.

This transmittal letter is submitted in duplicate for accounting purposes.

Respectfully submitted,

Shirley L. Church

Registration No. 31,858 Attorney for Applicants

Church

Correspondence Address:
Patent Counsel
Applied Materials, Inc.
P.O. Box 450-A
Santa Clara, California 95052



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INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR § 1.97(b)(1)

Hon. Commissioner for Patents Washington, DC 20231

Sir:

In accordance with 37 CFR § 1.97(b)(1), applicants hereby request consideration of this Information Disclosure Statement. This Information Disclosure Statement is being submitted within three (3) months of the filing date of the subject application or before an Office Action on the merits. Applicants are providing herewith a copy of each document cited on the attached Form PTO-1449.

CERTIFICATE OF MAILING UNDER 37 CFR 1.10

I hereby certify that this paper is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as U.S. EXPRESS MAIL NO. ET160381264US in an envelope addressed to the: Commissioner for Patents, Box DD, Washington, DC 20231.

Date: <u>July 11, 2001</u>

Shirley L. Church, Reg. No. 31,858

The submission of this Information Disclosure Statement and Form PTO-1449 is not an admission that the art cited is "prior art" with respect to the present invention, nor is it a representation that no better art exists. Applicants hereby reserve the right to swear behind or otherwise disprove any alleged "prior" nature of any art cited should the facts support and the situation warrant such an action.

If the Examiner has any questions, he is respectfully requested to contact the undersigned attorney at the telephone number set forth below.

Respectfully submitted,

Shirley L. Church

Registration No. 31,858 Attorney for Applicants

Church

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P.O. Box 450-A
Santa Clara, California 95052



U.S. Department of Commerce Patent and Trademark Office U.S. Application Serial No. 09/882,323

Atty. Docket No. AM-2772.P1

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use several sheets if necessary)

Ajay Kumar et al. Applicants

June 13, 2001 Filing Date

Group

U. S. PATENT DOCUMENTS

Examiner Initial	Document Number	Issue Date	Name	Class	Subclass	Filing Date If Appropriate
	Re. 30,505	02/03/81	Jacob	156	643	
	4,615,764*	10/07/86	Bobbio et al.	156	643	
	4,793,897	12/27/88	Dunfield et al.	156	643	
	5,211,790	05/18/93	Tatsumi	156	662	
	5,362,361	11/08/94	Tatsumi	156	662	
	5,397,431	03/14/95	Kadomura	156	662	
	5,721,090*	02/24/98	Okamoto et al.	430	313	
	5,753,418	05/19/98	Tsai et al.	430	313	
	5,779,926*	07/14/98	Ma et al.	216	67	
	5,817,579	10/06/98	Ko et al.	438	740	
	5,910,392*	06/08/99	Nozaki et al.	430	270.1	
	5,911,887*	06/15/99	Smith et al.	216	72	

Examiner

Date Considered

Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

* Cited by the Examiner in the parent application.

/			U. S. PATENT DOCUM	ENTE		
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Examiner Initial	Document Number	Issue <u>Date</u>	Name	Class	Subclass	Filing Date If Appropriate
	6,080,678	06/27/00	Yim	438	725	
	6,110,826*	08/29/00	Lou et al.	438	674	
	6,132,631*	10/17/00	Nallan et al.	216	16	
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	WO 9616437	05/30/96	Chen	H01L	21/311	
	OTHER	DOCUMEN	ITS (Including Author, Title,	Date, Pertin	ent Pages, etc	······································
	W. R. Runyan Wesley Publisl	and K. E. Be	ean, "Semiconductor integrate ny, pp. 268 - 280 (1990).	ed circuit pro	ocessing tech	nology," Addison
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aminer		Date Con	sidered			

Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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